


WIRE BOND PAD / CONNECTOR PIN INTERCONNECTION PLAN

W/B No.	PIN No.	W/B No.	PIN No.	W/B No.	PIN No.	W/B No.	PIN No.	W/B No.	PIN No.
1	B10	21	A1	41	J2	61	L10	81	C11
2	B9	22	B2	42	L1	62	K9	82	B11
3	A10	23	C2	43	K2	63	L11	83	C10
4	A9	24	B1	44	K3	64	K10	84	A11
5	B8	25	C1	45	L2	65	J10		
6	A8	26	D2	46	L3	66	K11	S/R	NC
7	B6	27	D1	47	K4	67	J11	D/A	NC
8	B7	28	E3	48	L4	68	H10		
9	A7	29	E2	49	J5	69	H11		
10	C7	30	E1	50	K5	70	F10		
11	C6	31	F2	51	L5	71	G10		
12	A6	32	F3	52	K6	72	G11		
13	A5	33	G3	53	J6	73	G9		
14	B5	34	G1	54	J7	74	F9		
15	C5	35	G2	55	L7	75	F11		
16	A4	36	F1	56	K7	76	E11		
17	B4	37	H1	57	L6	77	E10		
18	A3	38	H2	58	L8	78	E9		
19	A2	39	J1	59	K8	79	D11		
20	B3	40	K1	60	L9	80	D10		

MODIFICATION						NAME 84 PIN GRID ARRAY PACKAGE	TOLERANCE UNLESS OTHERWISE SPECIFIED	DRAWN H.I	CHECKED S.A	APPROVED T.A	DATE MAR.28.'88
						SCALE /	MATERIAL —				
							THIRD ANGLE PROJECTION				
	CHANGED	DATE	DRAWN	CHECKED	APPROVED		KYOCERA CORPORATION KYOTO JAPAN	DRAWING NO. KD-P88187	SHEET 3/3		

